

CPC**COOPERATIVE PATENT CLASSIFICATION****G01K****MEASURING TEMPERATURE; MEASURING QUANTITY OF HEAT; THERMALLY-SENSITIVE ELEMENTS NOT OTHERWISE PROVIDED FOR**

(sensing temperature changes for compensating measurements of other variables for compensating readings of instruments for variation in temperature, see [G01D](#) or relevant subclasses for variable measured; radiation pyrometry [G01J](#); investigating or analysing materials by use of thermal means [G01N 25/00](#); compound sensitive elements, e.g. bimetallic, [G12B 1/02](#))

NOTE

1. In this subclass, the following term is used with the meaning indicated :
 - "thermometer" includes thermally-sensitive elements not provided for in other subclasses.
2. Attention is drawn to the Notes following the title of class [G01](#).
3. Attention is drawn to the Notes following the titles of class [B81](#) and subclass [B81B](#) relating to "micro-structural devices" and "micro-structural systems".

G01K 1/00**Details of thermometers not specially adapted for particular types of thermometer** (circuits for reducing thermal inertia [G01K 7/42](#))

- G01K 1/02 . Special applications of indicating or recording means, e.g. for remote indications
- G01K 1/022 .. {recording means}
- G01K 1/024 .. {for remote indication (remote indication per se [G08C](#))}
- G01K 1/026 .. {arrangements for monitoring a plurality of temperatures, e.g. by multiplexing}
- G01K 1/028 .. {arrangements for numerical indication}
- G01K 1/04 .. Scales
- G01K 1/045 ... {temperature indication combined with the indication of another variable (indicating of human comfort [G01W 1/17](#))}
- G01K 1/06 ... Arrangements for facilitating reading, e.g. illumination, magnifying glass
- G01K 1/065 {of liquid column thermometers}
- G01K 1/08 . Protective devices, e.g. casings
- G01K 1/083 .. {for clinical thermometers, e.g. contamination preventing sleeves}
- G01K 1/086 ... {for tympanic thermometers}
- G01K 1/10 .. for preventing chemical attack
- G01K 1/105 ... {for siderurgical use}
- G01K 1/12 .. for preventing damage due to heat overloading
- G01K 1/125 ... {for siderurgical use}
- G01K 1/14 . Supports; Fastening devices; Mounting thermometers in particular locations
- G01K 1/143 .. {for measuring surface temperatures, e.g. of pipe walls}
- G01K 1/146 .. {arrangements for moving thermometers to or from a measuring position}
- G01K 1/16 . Special arrangements for conducting heat from the object to the sensitive element

- G01K 1/165 . . . {for application in zero heat flux sensors}
- G01K 1/18 . . . for reducing thermal inertia
- G01K 1/20 . . . Compensating for effects of temperature changes other than those to be measured, e.g. changes in ambient temperature
- G01K 1/22 . . . by means of fluid contained in a hollow body having parts which are deformable or displaceable under the pressure developed by the fluid
- G01K 1/24 . . . by means of compounded strips or plates, e.g. by bimetallic strips
- G01K 1/26 . . . Compensating for effects of pressure changes

G01K 3/00 **Thermometers giving results other than momentary value of temperature**
(G01K 7/42 takes precedence)

- G01K 3/005 . . . {Circuits arrangements for indicating a predetermined temperature (fire detection G08B 17/00)}
- G01K 3/02 . . . giving means values; giving integrated values
- G01K 3/04 . . . in respect of time
- G01K 3/06 . . . in respect of space
- G01K 3/08 . . . giving differences of values (using thermoelectric elements G01K 7/02); giving differentiated values
- G01K 3/10 . . . in respect of time, e.g. reacting only to a quick change of temperature
- G01K 3/12 . . . based upon expansion or contraction of materials
- G01K 3/14 . . . in respect of space
- G01K 2003/145 . . . {Hotspot localization}

G01K 5/00 **Measuring temperature based on the expansion or contraction of a material**
(G01K 9/00 takes precedence; giving other than momentary value of temperature G01K 3/00; of vapour arising from a liquid G01K 11/02; thermally-actuated switches H01H)

- G01K 5/02 . . . the material being a liquid (contained in a hollow body having parts which are deformable or displaceable under the pressure developed by the material G01K 5/32)
- G01K 5/025 . . . {Manufacturing of this particular type of thermometer}
- G01K 5/04 . . . Details
- G01K 5/06 . . . Arrangements for driving back the liquid column
- G01K 5/08 . . . Capillary tubes
- G01K 5/10 . . . Containers for the liquid
- G01K 5/12 . . . Selection of liquid compositions
- G01K 5/14 . . . the liquid displacing a further liquid column or a solid body (for maximum or minimum indication G01K 5/20)
- G01K 5/16 . . . with electric contacts
- G01K 5/18 . . . with electric conversion means for final indication
- G01K 5/20 . . . with means for indicating a maximum or a minimum or both (G01K 5/22 takes precedence)
- G01K 5/22 . . . with provision for expansion indicating over not more than a few degrees, e.g. clinical thermometer
- G01K 5/225 . . . {with means for indicating a maximum, e.g. a constriction in the capillary tube}

- G01K 5/24 .. with provision for measuring the difference between two temperatures
- G01K 5/26 .. with provision for adjusting zero point of scale, e.g. Beckmann thermometer
- G01K 5/28 . the material being a gas (contained in a hollow body having parts which are deformable or displaceable under the pressure developed by the material [G01K 5/32](#))
- G01K 5/30 .. the gas displacing a liquid column
- G01K 5/32 . the material being a fluid contained in a hollow body having parts which are deformable or displaceable (under pressure developed by evaporation [G01K 11/04](#); pressure measuring devices in general [G01L](#))
- G01K 5/323 .. {Selection of fluid compositions}
- G01K 5/326 .. {using a fluid container connected to the deformable body by means of a capillary tube}
- G01K 5/34 .. the body being a capsule ([G01K 5/36](#), [G01K 5/42](#) take precedence)
- G01K 5/36 .. the body being a tubular spring, e.g. Bourdon tube
- G01K 5/38 ... of spiral formation
- G01K 5/40 ... of helical formation
- G01K 5/42 .. the body being a bellows
- G01K 5/44 .. the body being a cylinder and piston
- G01K 5/46 .. with electric conversion means for final indication
- G01K 5/465 ... {using electrical contact making or breaking devices}
- G01K 5/48 . the material being a solid
- G01K 5/483 .. {using materials with a configuration memory e.g. Ni-Ti alloys}
- G01K 5/486 .. {using microstructures, e.g. made of silicon ([G01K 7/015](#), [G01K 7/028](#), [G01K 7/226](#), [G01K 17/006](#) take precedence)}
- G01K 5/50 .. arranged for free expansion or contraction
- G01K 5/52 ... with electrical conversion means for final indication
- G01K 5/54 .. consisting of pivotally-connected elements
- G01K 5/56 .. constrained so that expansion or contraction causes a deformation of the solid
- G01K 5/58 ... the solid body being constrained at more than one point, e.g. rod, plate, diaphragm ([G01K 5/62](#) takes precedence)
- G01K 5/60 the body being a flexible wire or ribbon
- G01K 5/62 ... the solid body being formed of compounded strips or plates, e.g. bimetallic strip
- G01K 5/64 Details of the compounds system
- G01K 5/66 Selection of composition of the components of the system
- G01K 5/68 Shape of the system
- G01K 5/70 specially adapted for indicating or recording
- G01K 5/72 with electric transmission means for final indication
- G01K 7/00** **Measuring temperature based on the use of electric or magnetic elements directly sensitive to heat** (giving results other than momentary value of temperature [G01K 3/00](#); measuring electric or magnetic variables [G01R](#)); {Power supply, e.g. by thermoelectric elements}
- G01K 7/003 . {using pyroelectric elements (radiation pyrometers [G01J 5/00](#))}
- G01K 7/006 . {using superconductive elements}

- G01K 7/01 . using semiconducting elements having PN junctions ([G01K 7/02](#), [G01K 7/16](#), [G01K 7/30](#) take precedence)
- G01K 7/015 . . {using microstructures, e.g. made of silicon}
- G01K 7/02 . using thermoelectric elements, e.g. thermocouples ({cooling arrangements in electronic devices using the Peltier effect [H01L 23/38](#);} thermo-electric or thermo-magnetic devices per se [H01L 35/00](#), [H01L 37/00](#))
- G01K 7/021 . . {Particular circuit arrangements ([G01K 7/026](#), [G01K 7/12](#), [G01K 7/14](#) take precedence)}
- G01K 7/023 . . {provided with specially adapted connectors (connectors per se [H01R](#))}
- G01K 7/025 . . {expendable thermocouples}
- G01K 7/026 . . {Arrangements for signalling rupture or disconnection of the thermocouple}
- G01K 7/028 . . {using microstructures, e.g. made of silicon}
- G01K 7/04 . . the object to be measured not forming one of the thermo-electric materials
- G01K 7/06 . . . the thermo-electric materials being arranged one within the other with the junction at one end exposed to the object, e.g. sheathed type
- G01K 7/08 . . the object to be measured forming one of the thermo-electric materials, e.g. pointed type
- G01K 7/10 . . Arrangements for compensating for auxiliary variables, e.g. length of lead
- G01K 7/12 . . . Arrangements with respect to the cold junction, e.g. preventing influence of temperature of surrounding air
- G01K 7/13 Circuits for cold-junction compensation
- G01K 7/14 . . Arrangements for modifying the output characteristic, e.g. linearising
- G01K 7/16 . using resistive elements ([resistive elements](#) per se [H01C](#), [H01L](#))
- G01K 2007/163 . . {provided with specially adapted connectors}
- G01K 2007/166 . . {Electrical time domain reflectometry}
- G01K 7/18 . . the element being a linear resistance, e.g. platinum resistance thermometer ([G01K 7/26](#) takes precedence)
- G01K 7/183 . . . {characterised by the use of the resistive element}
- G01K 7/186 . . . {using microstructures}
- G01K 7/20 . . in a specially-adapted circuit, e.g. bridge circuit
- G01K 7/203 . . . {in an oscillator circuit}
- G01K 7/206 . . . {in a potentiometer circuit}
- G01K 7/21 . . . for modifying the output characteristic, e.g. linearising
- G01K 7/22 . . the element being a non-linear resistance, e.g. thermistor ([G01K 7/26](#) takes precedence)
- G01K 7/223 . . . {characterised by the shape of the resistive element}
- G01K 7/226 . . . {using microstructures, e.g. silicon spreading resistance}
- G01K 7/24 . . in a specially-adapted circuit, e.g. bridge circuit
- G01K 7/245 . . . {in an oscillator circuit}
- G01K 7/25 . . . for modifying the output characteristic, e.g. linearising
- G01K 7/26 . . the element being an electrolyte
- G01K 7/28 . . in a specially-adapted circuit, e.g. bridge circuit

- G01K 7/30 . using thermal noise of resistances or conductors
- G01K 7/32 . using change of resonant frequency of a crystal
- G01K 7/34 . using capacitive elements ([capacitors per se H01G](#))
- G01K 7/343 .. {the dielectric constant of which is temperature dependant}
- G01K 7/346 .. {for measuring temperature based on the time delay of a signal through a series of logical ports}
- G01K 7/36 . using magnetic elements, e.g. magnets, coils ([magnetic elements per se H01F](#))
- G01K 7/38 .. the variations of temperature influencing the magnetic permeability
- G01K 7/40 . using ionisation of gases
- G01K 7/42 . Circuits for reducing thermal inertia; Circuits for predicting the stationary value of temperature
- G01K 2007/422 .. {Dummy objects used for estimating temperature of real objects}
- G01K 7/425 .. {Thermal management of integrated systems}
- G01K 7/427 .. {Temperature calculation based on spatial modeling, e.g. spatial inter- or extrapolation}

- G01K 9/00** **Measuring temperature based on movements caused by redistribution of weight, e.g. tilting thermometer (not giving momentary value of temperature [G01K 3/00](#))**

- G01K 11/00** **Measuring temperature based upon physical or chemical changes not covered by groups [G01K 3/00](#), [G01K 5/00](#), [G01K 7/00](#) or [G01K 9/00](#)**
- G01K 11/003 . {using absorption or generation of gas, e.g. hydrogen}
- G01K 11/006 . {using measurement of the effect of a material on microwaves or longer electromagnetic waves, e.g. measuring temperature via microwaves emitted by the object ([G01K 17/003](#), [G01J 5/00](#) take precedence; measuring the effect of a material on X-, gamma- or particle radiation [G01K 11/30](#))}
- G01K 11/02 . using evaporation or sublimation, e.g. by observing boiling
- G01K 11/04 .. from material contained in a hollow body having parts which are deformable or displaceable under the pressure developed by the vapour
- G01K 11/06 . using melting, freezing, or softening
- G01K 11/08 .. of disposable test bodies, e.g. cone
- G01K 11/10 . using sintering
- G01K 11/12 . using change of colour or translucency ([G01K 11/32](#) takes precedence; heat-sensitive sheets for use in thermography [B41M 5/00](#); {tenebrescent compositions [C09K 9/00](#)})
- G01K 11/125 .. {using change in reflectance}
- G01K 11/14 .. of inorganic materials
- G01K 11/16 .. of organic materials
- G01K 11/165 ... {liquid crystals (liquid crystal compositions [C09K 19/00](#); electro-optic liquid crystals [G02F 1/13](#))}
- G01K 11/18 .. of materials which change translucency
- G01K 11/20 . using thermoluminescent materials ([G01K 11/32](#) takes precedence)
- G01K 11/22 . using measurement of acoustic effects
- G01K 11/24 .. of the velocity of propagation of sound

- G01K 11/26 . . of resonant frequencies
- G01K 11/265 . . . {using surface acoustic wave [SAW]}
- G01K 11/28 . using measurements of density (measuring density in general [G01N 9/00](#))
- G01K 11/30 . using measurement of the effect of a material on X-radiation, gamma radiation or particle radiation
- G01K 11/32 . using changes in transmission, scattering or fluorescence in optical fibres {(in general [G01D 5/268](#))}
- G01K 11/3206 . . {at discrete locations in the fibre, e.g. by means of Bragg gratings}
- G01K 11/3213 . . . {using changes in fluorescence, e.g. at the distal end of the fibre}
- G01K 2011/322 . . {using Brillouin scattering}
- G01K 2011/324 . . {using Raman scattering}

G01K 13/00**Adaptations of thermometers for specific purposes**

- G01K 13/002 . {for measuring body temperature ([G01K 5/22](#) takes precedence; for prediction aspects [G01K 7/42](#); diagnostic temperature sensing [A61M 39/0247](#))}
- G01K 13/004 . . {Infrared clinical thermometers, e.g. tympanic}
- G01K 13/006 . {for cryogenic purposes}
- G01K 13/008 . . {using microstructures, e.g. made of silicon}
- G01K 13/02 . for measuring temperature of moving fluids or granular materials capable of flow
- G01K 13/022 . . {Suction thermometers}
- G01K 2013/024 . . {Moving gas}
- G01K 2013/026 . . {Moving liquid}
- G01K 13/028 . . {for use in total air temperature [TAT] probes}
- G01K 13/04 . for measuring temperature of moving solid bodies
- G01K 13/06 . . in linear movement
- G01K 13/08 . . in rotary movement
- G01K 13/10 . for measuring temperature within piled or stacked materials (by special arrangements for conducting heat from the object to the sensitive heat element [G01K 1/16](#))
- G01K 13/12 . combined with sampling devices for measuring temperatures of samples of materials
- G01K 13/125 . . {for siderurgical purposes}

G01K 15/00**Testing or calibrating of thermometers**

- G01K 15/002 . {Calibrated temperature sources, temperature standards therefor (arrangements with respect to the cold junction of thermo-electric elements [G01K 7/12](#))}
- G01K 15/005 . {Calibration}
- G01K 15/007 . {Testing}

G01K 17/00**Measuring quantity of heat** (measuring temperature by calorimetry [G01K 3/00](#) to [G01K 11/00](#); specially adapted for measuring thermal properties of materials, e.g. specific heat, heat of combustion [G01N](#))

- G01K 17/003 . {for measuring the power of light beams, e.g. laser beams}
- G01K 17/006 . {Microcalorimeters, e.g. using silicon microstructures}

- G01K 17/02 . Calorimeters using transport of an indicating substances, e.g. evaporation calorimeters
- G01K 17/025 . . {where evaporation, sublimation or condensation caused by heating or cooling, is measured}
- G01K 17/04 . Calorimeters using compensation methods {i.e. where the absorbed or released quantity of heat to be measured is compensated by a measured quantity of heating or cooling}
- G01K 17/06 . Measuring quantity of heat conveyed by flowing mediums, e.g. in heating systems (G01K 17/02, G01K 17/04 take precedence) {e.g. the quantity of heat in a transporting medium, delivered to or consumed in an expenditure device}
- G01K 17/08 . . based upon measurement of temperature difference {or of a temperature}
- G01K 17/10 . . . between an inlet and an outlet point, combined with measurement of rate of flow of the medium {if such, by integration during a certain time-interval}
- G01K 17/12 Indicating product of flow and temperature difference directly {or temperature}
- G01K 17/14 using mechanical means for both measurements
- G01K 17/16 using electrical {or magnetic} means for both measurements
- G01K 17/18 using electrical {or magnetic} means for one measurement and mechanical means for the other
- G01K 17/185 {where the indicating-instrument is driven electrically or magnetically by the temperature-measurement device and mechanically by the flow-measurement device}
- G01K 17/20 . . . across a radiating surface, combined with ascertainment of the heat transmission coefficient {(materials therefor G01K 17/08)}

- G01K 19/00 Testing or calibrating calorimeters**

- G01K 2201/00 Application of thermometers in air-conditioning systems**
- G01K 2201/02 . in vehicles

- G01K 2203/00 Application of thermometers in cryogenics**

- G01K 2205/00 Application of thermometers in motors, e.g. of a vehicle**
- G01K 2205/02 . for measuring inlet gas temperature
- G01K 2205/04 . for measuring exhaust gas temperature

- G01K 2207/00 Application of thermometers in household appliances**
- G01K 2207/02 . for measuring food temperature
- G01K 2207/04 . . for conservation purposes
- G01K 2207/06 . . for preparation purposes
- G01K 2207/08 . . with food recipients having temperature sensing capability

- G01K 2211/00 Thermometers based on nanotechnology**

- G01K 2213/00 Temperature mapping**

- G01K 2215/00 Details concerning sensor power supply**

- G01K 2217/00** **Temperature measurement using electric or magnetic components already present in the system to be measured**
- G01K 2219/00** **Thermometers with dedicated analog to digital converters**